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CENTRAL FAX CENTER****Patent****FEB 14 2006**

Customer No.: 31561

Docket No.: 10788-US-PA

Application No.: 10/709,923

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Huang et al.

Application No. : 10/709,923

Filed : 2004/6/7

For : FLIP-CHIP PACKAGE SUBSTRATE AND FLIP-CHIP
BONDING PROCESS THEREOF

Art Unit : 2826

Examiner : CHAMBLISS, ALONZO

TRANSMITTAL LETTER

002-1-571-273-8300

(Via fax : 1+7 pages)

Assistant Commissioner for Patents
Alexandria, VA 22314

Dear Sir,

In response to the Office Action dated November 14, 2005(Paper No.: 20051108), please find the Response to Office Action, in 7 pages.

I believe that no fee is incurred. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10788-US-PA).

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property OfficeDate : February 14, 2006By : Belinda Lee
Belinda Lee
Registration No.: 46,863

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)	Examiner: CHAMBLISS, ALONZO
)	
Huang et al.)	Art Unit: 2814
)	
Serial No.: 10/709,923)	
)	<u>AMENDMENT</u>
Filed: June 7, 2004)	
)	
For: Flip-Chip Package Substrate And)	Docket No.: 10788-US-PA
Flip-Chip Bonding Process Thereof)	

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10788-US-PA)

AMENDMENTS AND RESPONSE TO OFFICE ACTION

United States Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

The Office Action dated November 14, 2005, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

Customer No.: 31561
Application No.: 10/709,923
Docket No.: 10788-US-PA

AMENDMENTS

To the Title:

Please substitute the title by

--FLIP CHIP PACKAGE PROCESS--.